

SN54LS320, SN54LS321, SN74LS320, SN74LS321 CRYSTAL-CONTROLLED OSCILLATORS

SDLS158 – DECEMBER 1978 – REVISED MARCH 1988

'LS320

- Crystal-Controlled Oscillator Operation from 1 MHz to 20 MHz
- 2-Phase Driver Outputs

'LS321

- Similar to 'LS320 But Includes f/2 and f/4 Count-Down Outputs

description

The 'LS320 is a crystal-controlled oscillator/clock driver. It features complementary standard and high-current driver outputs. A synchronization flip-flop is included.

The driver outputs, F' and $\bar{F}'$ have very-low impedance and can be used to drive highly capacitive TTL-level lines. If the driver outputs are not used, then the VCC' terminal can be left open.

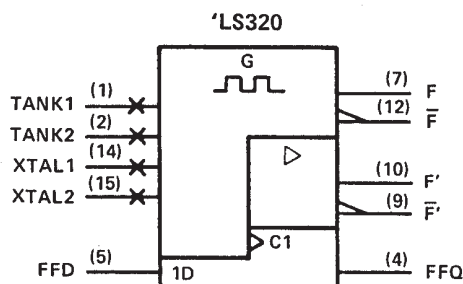
The 'LS321 is identical to the 'LS320 except it additionally features two count-down outputs, F/2 and F/4.

These circuits were designed for crystal control of frequency and capacitive control is not recommended. If a fundamental crystal is used, an inductor of 5 to 160 μ H is required to be connected between the tank 1 and tank 2 inputs. †

Interaction of the driver outputs with the other outputs limits useful frequencies as shown in the frequency-limits table.

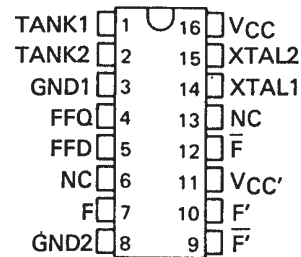
The SN54LS320 and SN54LS321 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74LS320 and SN74LS321 are characterized for operation from 0°C to 70°C.

logic symbols†



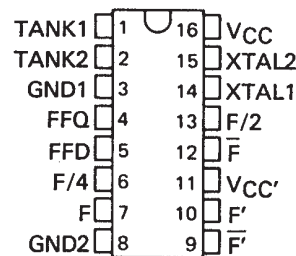
SN54LS320 . . . J OR W PACKAGE
SN74LS320 . . . N PACKAGE

(TOP VIEW)



SN54LS321 . . . J PACKAGE
SN74LS321 . . . N PACKAGE

(TOP VIEW)



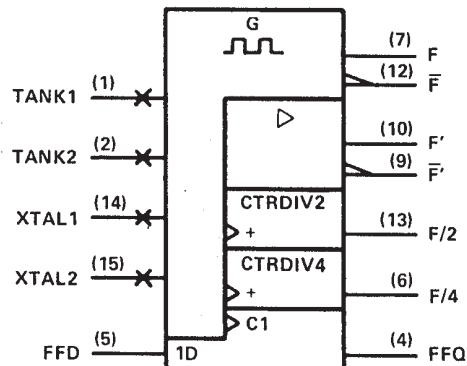
NC – No internal connection.

For chip carrier information,
contact the factory.

FREQUENCY LIMITS

OUTPUTS IN USE	VCC	VCC'	f _{max}
Driver outputs only	5 V	5 V	20 MHz
Other outputs only	5 V	Open	20 MHz
Driver and any other outputs	5 V	5 V	10 MHz

'LS321



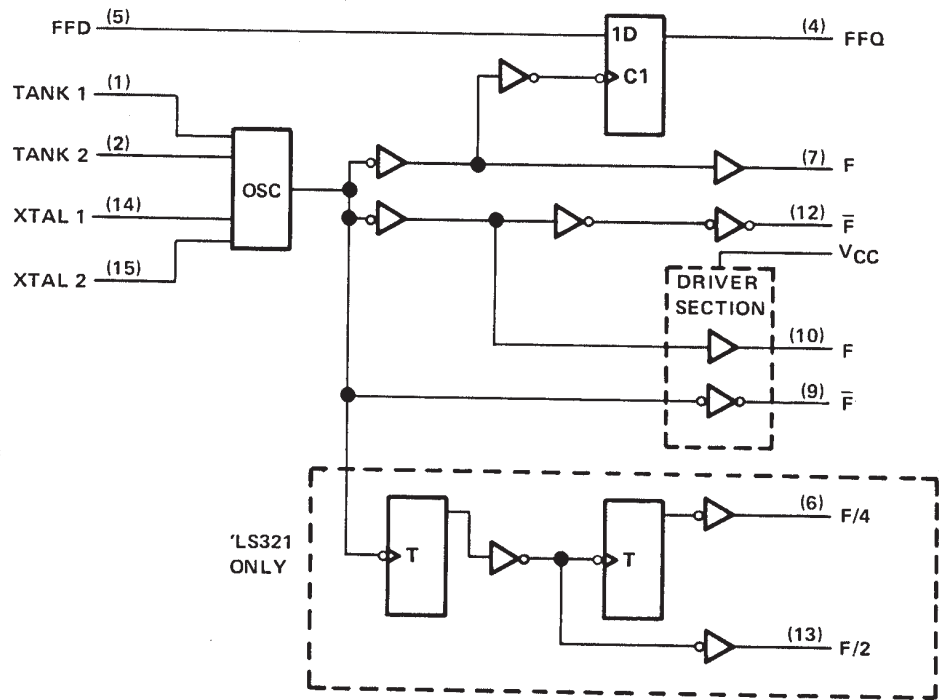
†The value of the inductor is selected from the graph in Figure 2. Use the next higher standard inductor value if the selected value is not available. If a third overtone crystal is used, a tuned tank is necessary. The center frequency of the tuned tank is determined by the equation $f = \frac{1}{2} \pi \sqrt{LC}$.

‡These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

SN54LS320, SN54LS321, SN74LS320, SN74LS321
CRYSTAL-CONTROLLED OSCILLATORS

SDLS158 – DECEMBER 1978 – REVISED MARCH 1988

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Supply voltage, V_{CC}'	7 V
Input voltage to FFD terminal	-0.5 V to 7 V
Operating free-air temperature range: SN54LS320, SN54LS321	-55°C to 125°C
SN74LS320, SN74LS321	0°C to 70°C
Storage temperature range	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminals.

recommended operating conditions

		SN54LS320 SN54LS321			SN74LS320 SN74LS321			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
Supply voltage, V_{CC}'		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}	F' or $\bar{F}'$			-12			-24	mA
	$F, \bar{F}, F/2, F/4$			-0.4			-0.4	
Low-level output current, I_{OL}	F' or $\bar{F}'$			12			24	mA
	$F, \bar{F}, F/2, F/4$			4			8	
Output frequency, f_{out}	$F/2$ ('LS321)	0.5		10	0.5		10	MHz
	$F/4$ ('LS321)	0.25		5	0.25		5	
	F or $\bar{F}$	1		20	1		20	
Operating free-air temperature, T_A		-55		125	0		70	°C

Input and output schematics are similar to those shown for SN74LS326.



SN54LS320, SN54LS321, SN74LS320, SN74LS321 CRYSTAL-CONTROLLED OSCILLATORS

SDLS158 – DECEMBER 1978 – REVISED MARCH 1988

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		SN54LS320 SN54LS321		SN74LS320 SN74LS321		UNIT		
				MIN	TYP‡	MAX	MIN		TYP‡	MAX
V _{IH}	High-level input voltage			2			2	V		
V _{IL}	Low-level input voltage					0.7		0.8	V	
V _{IK}	Input clamp voltage	V _{CC} = MIN, V _{CC} ' = MIN, I _I = -18 mA				-1.5		-1.5	V	
V _{OH}	High-level output voltage	F', F̄	V _{CC} = 4.5 V, V _{CC} ' = 4.5 V, I _{OH} = -12 mA	2.4	3.3				V	
			V _{CC} = 4.75 V, V _{CC} ' = 4.75 V, I _{OH} = -24 mA			2.7	3.3			
		Others	V _{CC} = MIN, V _{IH} = 2 V, I _{OH} = -400 μA	2.4	3.4		2.7	3.4		
V _{OL}	Low-level output voltage	F', F̄	V _{CC} = MIN, V _{CC} ' = MIN	I _{OL} = 12 mA	0.25	0.4	0.25	0.4	V	
				I _{OL} = 24 mA			0.35	0.5		
		Others	V _{CC} = MIN, V _{IL} = V _{IL} max	I _{OL} = 4 mA	0.25	0.4	0.25	0.4		
				I _{OL} = 8 mA			0.35	0.5		
I _I	Input current at maximum input voltage	V _{CC} = MAX, V _I = 7 V				0.1		0.1	mA	
I _{IH}	High-level input current	V _{CC} = MAX, V _I = 2.7 V				20		20	μA	
I _{IL}	Low-level input current	V _{CC} = MAX, V _I = 0.4 V				-0.4		-0.4	mA	
I _{OS}	Short-circuit output current§	V _{CC} = MAX		-20		-100	-20	-100	mA	
I _{CC}	Supply current from V _{CC}	V _{CC} = MAX, FFD at GND	'LS320	42	70	42	70		mA	
			'LS321	47	75	47	75			
I _{CC} '	Supply current from V _{CC} '	V _{CC} = MAX, V _{CC} ' = MAX, FFD at GND			4	8	4	8	mA	

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡All typical values are at V_{CC} = 5 V, V_{CC'} = 5 V, and T_A = 25°C.

§Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second. Outputs F' and F' do not have short-circuit protection and these limits do not apply.

switching characteristics, V_{CC} = 5 V, V_{CC'} = 5 V, T_A = 25°C

PARAMETER	OUTPUTS	TEST CONDITIONS¹		'LS320			'LS321			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
f _{max}	Maximum operating frequency	C _L = 100 pF	R _L = 667 Ω				10	15		MHz
			R _L = 2 kΩ	20	30		20	30		
t _r	F', F'	C _L = 50 pF	R _L = 667 Ω	6	12		6	12		ns
				7	14		7	14		
				7	14		7	14		
	Others	C _L = 50 pF	R _L = 2 kΩ	11	22		11	22		
				25	40		25	40		
				45	70		45	70		
t _f	F', F'	C _L = 50 pF	R _L = 667 Ω	5	10		5	10		ns
				5	10		5	10		
				6	12		6	12		
	Others	C _L = 50 pF	R _L = 2 kΩ	6	12		6	12		
				10	20		10	20		
				17	30		17	30		

¹Load circuits and voltage waveforms are shown in Section 1.



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SDLS158 – DECEMBER 1978 – REVISED MARCH 1988

TYPICAL APPLICATION DATA

The SN54/74LS320 and 'LS321 are crystal-controlled oscillators. Figure 1 shows the device with all required external components.

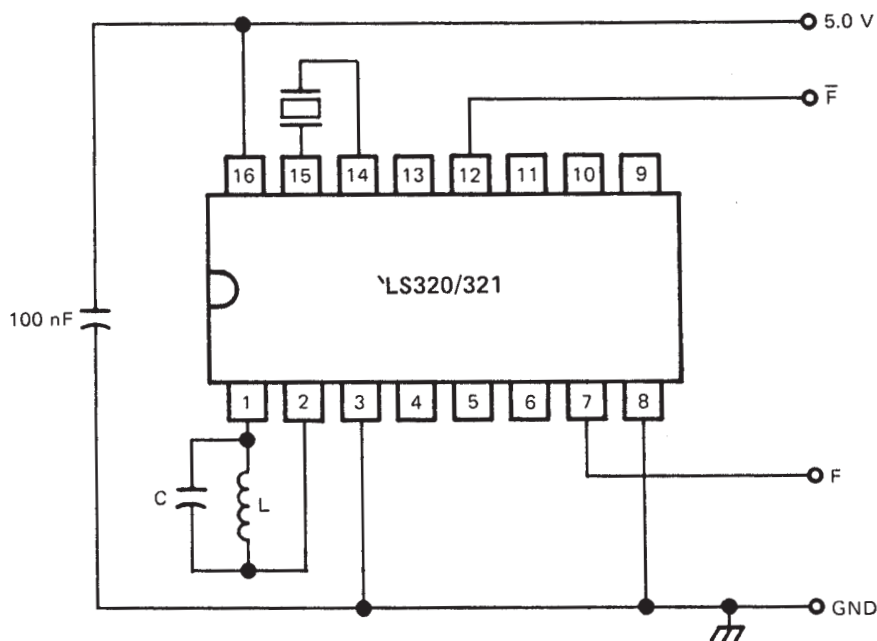


FIGURE 1. CRYSTAL-CONTROLLED OSCILLATOR 'LS320/321

1. Determination of C and L are as follows:
 - a. Inductance L
Select Inductance L according to Figure 2.
 - b. Capacitor C

$$C = C_S - C_P - C_L$$

Where: C_P = parasitic board capacitance
 C_L = parasitic capacitance of the inductor
 L = inductance
 C_S = required capacitance calculated as follows:

$$C_S = \frac{1}{(2 \cdot \pi \cdot f_q)^2 \cdot L}$$

for $f_q > 12 \text{ MHz}$, $C = 0 \text{ pf}$

2. Electrical characteristic for the crystal:
 The quartz crystal used as a frequency reference should be designed for series mode operation with a resistance in the 20Ω to 75Ω range and be capable of a minimum 2 mw power dissipation.
 It is recommended to use a tuned tank also for fundamental crystals.

SN54LS320, SN54LS321, SN74LS320, SN74LS321 CRYSTAL-CONTROLLED OSCILLATORS

SDLS158 – DECEMBER 1978 – REVISED MARCH 1988

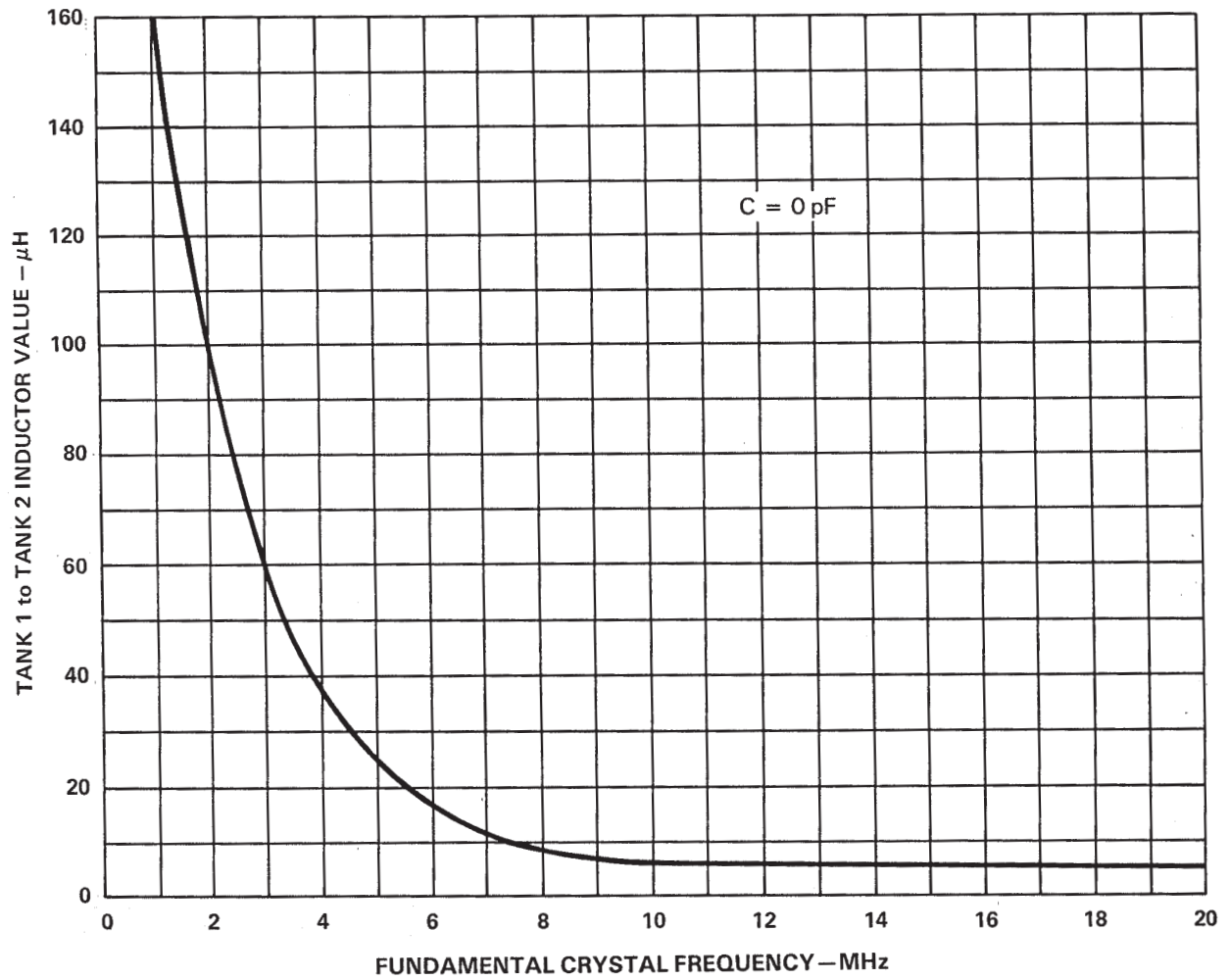


FIGURE 2

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